



Fabrication Drawing

NOTES : Unless Otherwise Specified

1. MATERIAL : FR4 OR EQUIVALENT EPOXY, 2 OZ. COPPER CLAD
 THICKNESS .062 +/- .006 TOTAL OF 6 LAYERS
 2. FINISH : ALL PLATED HOLES .001 MIN. / .0015 MAX. COPPER PLATE
 ELECTRODEPOSITED TIN-LEAD COMPOSITION
 BEFORE REFLow , SOLDER MASK OVER BARE COPPER (SMBC)
 3. SOLDER MASK : BOTH SIDES USING LPI OR EQUIVALENT
 4. SILKSCREEN : USING WHITE NON-CONDUCTIVE EPOXY INK
 5. ALL DIMENSIONS ARE IN INCHES